



Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	11519
Number of Logic Elements/Cells	147443
Total RAM Bits	4939776
Number of I/O	338
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc6slx150-2fg484c

Table 8: Recommended Operating Conditions for User I/Os Using Differential Signal Standards

I/O Standard	V _{CCO} for Drivers		
	V, Min	V, Nom	V, Max
LVDS_33	3.0	3.3	3.45
LVDS_25	2.25	2.5	2.75
BLVDS_25	2.25	2.5	2.75
MINI_LVDS_33	3.0	3.3	3.45
MINI_LVDS_25	2.25	2.5	2.75
LVPECL_33 ⁽¹⁾	N/A—Inputs Only		
LVPECL_25	N/A—Inputs Only		
RSDS_33	3.0	3.3	3.45
RSDS_25	2.25	2.5	2.75
TMDS_33 ⁽¹⁾	3.14	3.3	3.45
PPDS_33	3.0	3.3	3.45
PPDS_25	2.25	2.5	2.75
DISPLAY_PORT	2.3	2.5	2.7
DIFF_MOBILE_DDR	1.7	1.8	1.9
DIFF_HSTL_I	1.4	1.5	1.6
DIFF_HSTL_II	1.4	1.5	1.6
DIFF_HSTL_III	1.4	1.5	1.6
DIFF_HSTL_I_18	1.7	1.8	1.9
DIFF_HSTL_II_18	1.7	1.8	1.9
DIFF_HSTL_III_18	1.7	1.8	1.9
DIFF_SSTL3_I	3.0	3.3	3.45
DIFF_SSTL3_II	3.0	3.3	3.45
DIFF_SSTL2_I	2.3	2.5	2.7
DIFF_SSTL2_II	2.3	2.5	2.7
DIFF_SSTL18_I	1.7	1.8	1.9
DIFF_SSTL18_II	1.7	1.8	1.9
DIFF_SSTL15_II	1.425	1.5	1.575

Notes:

1. LVPECL_33 and TMDS_33 inputs require V_{CCAUX} = 3.3V nominal.

Production Silicon and ISE Software Status

In some cases, a particular family member (and speed grade) is released to production before a speed specification is released with the correct label (Advance, Preliminary, Production). Any labeling discrepancies are corrected in subsequent speed specification releases. [Table 27](#) lists the production released Spartan-6 family member, speed grade, and the minimum corresponding supported speed specification version and ISE® software revisions. The ISE software and speed specifications listed are the minimum releases required for production. All subsequent releases of software and speed specifications are valid.

Table 27: Spartan-6 Device Production Software and Speed Specification Release⁽¹⁾

Device	Speed Grade Designations ⁽²⁾			
	-3 ⁽³⁾	-3N	-2 ⁽⁴⁾	-1L
XC6SLX4	ISE 12.4 v1.15	N/A	ISE 12.3 v1.12 ⁽⁵⁾	ISE 13.2 v1.07
XC6SLX9	ISE 12.4 v1.15	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.3 v1.12 ⁽⁵⁾	ISE 13.2 v1.07
XC6SLX16	ISE 12.1 v1.08	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 11.5 v1.06	ISE 13.2 v1.07
XC6SLX25	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.2 v1.07
XC6SLX25T	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	N/A
XC6SLX45	ISE 12.1 v1.08	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 11.5 v1.07	ISE 13.1 v1.06
XC6SLX45T	ISE 12.1 v1.08	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.1 v1.08	N/A
XC6SLX75	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.2 v1.07
XC6SLX75T	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	N/A
XC6SLX100	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 v1.06
XC6SLX100T	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	N/A
XC6SLX150	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 v1.06
XC6SLX150T	ISE 12.2 v1.11 ⁽⁶⁾	ISE 13.1 Update v1.18 ⁽⁷⁾	ISE 12.2 v1.11 ⁽⁶⁾	N/A
XA6SLX4	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX9	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX16	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX25	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX25T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX45	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX45T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX75	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX75T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XA6SLX100	N/A	N/A	ISE 13.3 v1.20	N/A

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVC MOS33, Fast, 8 mA	1.34	1.46	1.59	1.82	2.07	2.21	2.41	3.03	2.07	2.21	2.41	3.03	ns
LVC MOS33, Fast, 12 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS33, Fast, 16 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS33, Fast, 24 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS25, QUIETIO, 2 mA	0.82	0.94	1.07	1.31	4.81	4.95	5.15	5.79	4.81	4.95	5.15	5.79	ns
LVC MOS25, QUIETIO, 4 mA	0.82	0.94	1.07	1.31	3.70	3.84	4.04	4.66	3.70	3.84	4.04	4.66	ns
LVC MOS25, QUIETIO, 6 mA	0.82	0.94	1.07	1.31	3.46	3.60	3.80	4.38	3.46	3.60	3.80	4.38	ns
LVC MOS25, QUIETIO, 8 mA	0.82	0.94	1.07	1.31	3.20	3.34	3.54	4.12	3.20	3.34	3.54	4.12	ns
LVC MOS25, QUIETIO, 12 mA	0.82	0.94	1.07	1.31	2.83	2.97	3.17	3.75	2.83	2.97	3.17	3.75	ns
LVC MOS25, QUIETIO, 16 mA	0.82	0.94	1.07	1.31	2.64	2.78	2.98	3.64	2.64	2.78	2.98	3.64	ns
LVC MOS25, QUIETIO, 24 mA	0.82	0.94	1.07	1.31	2.45	2.59	2.79	3.42	2.45	2.59	2.79	3.42	ns
LVC MOS25, Slow, 2 mA	0.82	0.94	1.07	1.31	3.78	3.92	4.12	4.76	3.78	3.92	4.12	4.76	ns
LVC MOS25, Slow, 4 mA	0.82	0.94	1.07	1.31	2.79	2.93	3.13	3.73	2.79	2.93	3.13	3.73	ns
LVC MOS25, Slow, 6 mA	0.82	0.94	1.07	1.31	2.73	2.87	3.07	3.66	2.73	2.87	3.07	3.66	ns
LVC MOS25, Slow, 8 mA	0.82	0.94	1.07	1.31	2.48	2.62	2.82	3.42	2.48	2.62	2.82	3.42	ns
LVC MOS25, Slow, 12 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns
LVC MOS25, Slow, 16 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns
LVC MOS25, Slow, 24 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.94	2.01	2.15	2.35	2.94	ns
LVC MOS25, Fast, 2 mA	0.82	0.94	1.07	1.31	3.35	3.49	3.69	4.31	3.35	3.49	3.69	4.31	ns
LVC MOS25, Fast, 4 mA	0.82	0.94	1.07	1.31	2.25	2.39	2.59	3.22	2.25	2.39	2.59	3.22	ns
LVC MOS25, Fast, 6 mA	0.82	0.94	1.07	1.31	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns
LVC MOS25, Fast, 8 mA	0.82	0.94	1.07	1.31	2.02	2.16	2.36	2.98	2.02	2.16	2.36	2.98	ns
LVC MOS25, Fast, 12 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS25, Fast, 16 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS25, Fast, 24 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS18, QUIETIO, 2 mA	1.18	1.30	1.43	2.04	5.92	6.06	6.26	6.80	5.92	6.06	6.26	6.80	ns
LVC MOS18, QUIETIO, 4 mA	1.18	1.30	1.43	2.04	4.74	4.88	5.08	5.63	4.74	4.88	5.08	5.63	ns
LVC MOS18, QUIETIO, 6 mA	1.18	1.30	1.43	2.04	4.05	4.19	4.39	4.96	4.05	4.19	4.39	4.96	ns
LVC MOS18, QUIETIO, 8 mA	1.18	1.30	1.43	2.04	3.71	3.85	4.05	4.63	3.71	3.85	4.05	4.63	ns
LVC MOS18, QUIETIO, 12 mA	1.18	1.30	1.43	2.04	3.35	3.49	3.69	4.27	3.35	3.49	3.69	4.27	ns
LVC MOS18, QUIETIO, 16 mA	1.18	1.30	1.43	2.04	3.20	3.34	3.54	4.14	3.20	3.34	3.54	4.14	ns
LVC MOS18, QUIETIO, 24 mA	1.18	1.30	1.43	2.04	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns
LVC MOS18, Slow, 2 mA	1.18	1.30	1.43	2.04	4.62	4.76	4.96	5.54	4.62	4.76	4.96	5.54	ns
LVC MOS18, Slow, 4 mA	1.18	1.30	1.43	2.04	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns
LVC MOS18, Slow, 6 mA	1.18	1.30	1.43	2.04	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns
LVC MOS18, Slow, 8 mA	1.18	1.30	1.43	2.04	2.19	2.33	2.53	3.17	2.19	2.33	2.53	3.17	ns
LVC MOS18, Slow, 12 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18, Slow, 16 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T _{IOPI}				T _{IOOP}				T _{IOTP}				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	-3	-3N	-2	-1L ⁽¹⁾	
LVC MOS15, Slow, 8 mA	0.98	1.10	1.23	1.79	2.30	2.44	2.64	3.25	2.30	2.44	2.64	3.25	ns
LVC MOS15, Slow, 12 mA	0.98	1.10	1.23	1.79	2.03	2.17	2.37	2.99	2.03	2.17	2.37	2.99	ns
LVC MOS15, Slow, 16 mA	0.98	1.10	1.23	1.79	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15, Fast, 2 mA	0.98	1.10	1.23	1.79	3.29	3.43	3.63	4.24	3.29	3.43	3.63	4.24	ns
LVC MOS15, Fast, 4 mA	0.98	1.10	1.23	1.79	2.27	2.41	2.61	3.22	2.27	2.41	2.61	3.22	ns
LVC MOS15, Fast, 6 mA	0.98	1.10	1.23	1.79	1.78	1.92	2.12	2.74	1.78	1.92	2.12	2.74	ns
LVC MOS15, Fast, 8 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.69	1.73	1.87	2.07	2.69	ns
LVC MOS15, Fast, 12 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.64	1.73	1.87	2.07	2.64	ns
LVC MOS15, Fast, 16 mA	0.98	1.10	1.23	1.79	1.73	1.87	2.07	2.64	1.73	1.87	2.07	2.64	ns
LVC MOS15_JEDEC, QUIETIO, 2 mA	1.03	1.15	1.28	1.49	5.49	5.63	5.83	6.37	5.49	5.63	5.83	6.37	ns
LVC MOS15_JEDEC, QUIETIO, 4 mA	1.03	1.15	1.28	1.49	4.61	4.75	4.95	5.51	4.61	4.75	4.95	5.51	ns
LVC MOS15_JEDEC, QUIETIO, 6 mA	1.03	1.15	1.28	1.49	4.07	4.21	4.41	4.97	4.07	4.21	4.41	4.97	ns
LVC MOS15_JEDEC, QUIETIO, 8 mA	1.03	1.15	1.28	1.49	3.92	4.06	4.26	4.81	3.92	4.06	4.26	4.81	ns
LVC MOS15_JEDEC, QUIETIO, 12 mA	1.03	1.15	1.28	1.49	3.54	3.68	3.88	4.51	3.54	3.68	3.88	4.51	ns
LVC MOS15_JEDEC, QUIETIO, 16 mA	1.03	1.15	1.28	1.49	3.33	3.47	3.67	4.31	3.33	3.47	3.67	4.31	ns
LVC MOS15_JEDEC, Slow, 2 mA	1.03	1.15	1.28	1.49	4.18	4.32	4.52	5.13	4.18	4.32	4.52	5.13	ns
LVC MOS15_JEDEC, Slow, 4 mA	1.03	1.15	1.28	1.49	3.42	3.56	3.76	4.35	3.42	3.56	3.76	4.35	ns
LVC MOS15_JEDEC, Slow, 6 mA	1.03	1.15	1.28	1.49	2.29	2.43	2.63	3.25	2.29	2.43	2.63	3.25	ns
LVC MOS15_JEDEC, Slow, 8 mA	1.03	1.15	1.28	1.49	2.30	2.44	2.64	3.26	2.30	2.44	2.64	3.26	ns
LVC MOS15_JEDEC, Slow, 12 mA	1.03	1.15	1.28	1.49	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15_JEDEC, Slow, 16 mA	1.03	1.15	1.28	1.49	2.01	2.15	2.35	2.97	2.01	2.15	2.35	2.97	ns
LVC MOS15_JEDEC, Fast, 2 mA	1.03	1.15	1.28	1.49	3.28	3.42	3.62	4.22	3.28	3.42	3.62	4.22	ns
LVC MOS15_JEDEC, Fast, 4 mA	1.03	1.15	1.28	1.49	2.27	2.41	2.61	3.23	2.27	2.41	2.61	3.23	ns
LVC MOS15_JEDEC, Fast, 6 mA	1.03	1.15	1.28	1.49	1.78	1.92	2.12	2.74	1.78	1.92	2.12	2.74	ns
LVC MOS15_JEDEC, Fast, 8 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.69	1.73	1.87	2.07	2.69	ns
LVC MOS15_JEDEC, Fast, 12 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.63	1.73	1.87	2.07	2.63	ns
LVC MOS15_JEDEC, Fast, 16 mA	1.03	1.15	1.28	1.49	1.73	1.87	2.07	2.63	1.73	1.87	2.07	2.63	ns
LVC MOS12, QUIETIO, 2 mA	0.91	1.03	1.16	1.51	6.40	6.54	6.74	7.30	6.40	6.54	6.74	7.30	ns
LVC MOS12, QUIETIO, 4 mA	0.91	1.03	1.16	1.51	4.98	5.12	5.32	5.90	4.98	5.12	5.32	5.90	ns
LVC MOS12, QUIETIO, 6 mA	0.91	1.03	1.16	1.51	4.65	4.79	4.99	5.55	4.65	4.79	4.99	5.55	ns
LVC MOS12, QUIETIO, 8 mA	0.91	1.03	1.16	1.51	4.23	4.37	4.57	5.21	4.23	4.37	4.57	5.21	ns
LVC MOS12, QUIETIO, 12 mA	0.91	1.03	1.16	1.51	3.98	4.12	4.32	4.94	3.98	4.12	4.32	4.94	ns
LVC MOS12, Slow, 2 mA	0.91	1.03	1.16	1.51	4.98	5.12	5.32	5.91	4.98	5.12	5.32	5.91	ns
LVC MOS12, Slow, 4 mA	0.91	1.03	1.16	1.51	2.84	2.98	3.18	3.81	2.84	2.98	3.18	3.81	ns
LVC MOS12, Slow, 6 mA	0.91	1.03	1.16	1.51	2.77	2.91	3.11	3.72	2.77	2.91	3.11	3.72	ns
LVC MOS12, Slow, 8 mA	0.91	1.03	1.16	1.51	2.34	2.48	2.68	3.31	2.34	2.48	2.68	3.31	ns
LVC MOS12, Slow, 12 mA	0.91	1.03	1.16	1.51	2.08	2.22	2.42	3.06	2.08	2.22	2.42	3.06	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
DIFF_SSTL3_I	1.26	1.44	1.95	2.15	1.95	2.15	ns
DIFF_SSTL3_II	1.26	1.44	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_I	1.09	1.27	1.94	2.14	1.94	2.14	ns
DIFF_SSTL2_II	1.09	1.27	1.90	2.10	1.90	2.10	ns
DIFF_SSTL18_I	1.04	1.22	1.86	2.06	1.86	2.06	ns
DIFF_SSTL18_II	1.05	1.23	1.82	2.02	1.82	2.02	ns
DIFF_SSTL15_II	1.01	1.19	1.81	2.01	1.81	2.01	ns
DIFF_MOBILE_DDR	1.04	1.22	1.89	2.09	1.89	2.09	ns
LVTTL, QUIETIO, 2 mA	1.42	1.60	5.64	5.84	5.64	5.84	ns
LVTTL, QUIETIO, 4 mA	1.42	1.60	4.46	4.66	4.46	4.66	ns
LVTTL, QUIETIO, 6 mA	1.42	1.60	3.92	4.12	3.92	4.12	ns
LVTTL, QUIETIO, 8 mA	1.42	1.60	3.37	3.57	3.37	3.57	ns
LVTTL, QUIETIO, 12 mA	1.42	1.60	3.42	3.62	3.42	3.62	ns
LVTTL, QUIETIO, 16 mA	1.42	1.60	3.09	3.29	3.09	3.29	ns
LVTTL, QUIETIO, 24 mA	1.42	1.60	2.83	3.03	2.83	3.03	ns
LVTTL, Slow, 2 mA	1.42	1.60	4.58	4.78	4.58	4.78	ns
LVTTL, Slow, 4 mA	1.42	1.60	3.38	3.58	3.38	3.58	ns
LVTTL, Slow, 6 mA	1.42	1.60	2.95	3.15	2.95	3.15	ns
LVTTL, Slow, 8 mA	1.42	1.60	2.73	2.93	2.73	2.93	ns
LVTTL, Slow, 12 mA	1.42	1.60	2.72	2.92	2.72	2.92	ns
LVTTL, Slow, 16 mA	1.42	1.60	2.53	2.73	2.53	2.73	ns
LVTTL, Slow, 24 mA	1.42	1.60	2.42	2.62	2.42	2.62	ns
LVTTL, Fast, 2 mA	1.42	1.60	4.04	4.24	4.04	4.24	ns
LVTTL, Fast, 4 mA	1.42	1.60	2.66	2.86	2.66	2.86	ns
LVTTL, Fast, 6 mA	1.42	1.60	2.58	2.78	2.58	2.78	ns
LVTTL, Fast, 8 mA	1.42	1.60	2.46	2.66	2.46	2.66	ns
LVTTL, Fast, 12 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 16 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVTTL, Fast, 24 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns
LVC MOS33, QUIETIO, 2 mA	1.41	1.59	5.65	5.85	5.65	5.85	ns
LVC MOS33, QUIETIO, 4 mA	1.41	1.59	4.20	4.40	4.20	4.40	ns
LVC MOS33, QUIETIO, 6 mA	1.41	1.59	3.65	3.85	3.65	3.85	ns
LVC MOS33, QUIETIO, 8 mA	1.41	1.59	3.51	3.71	3.51	3.71	ns
LVC MOS33, QUIETIO, 12 mA	1.41	1.59	3.09	3.29	3.09	3.29	ns
LVC MOS33, QUIETIO, 16 mA	1.41	1.59	2.91	3.11	2.91	3.11	ns
LVC MOS33, QUIETIO, 24 mA	1.41	1.59	2.73	2.93	2.73	2.93	ns
LVC MOS33, Slow, 2 mA	1.41	1.59	4.59	4.79	4.59	4.79	ns
LVC MOS33, Slow, 4 mA	1.41	1.59	3.14	3.34	3.14	3.34	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
LVC MOS15, QUIETIO, 2 mA	1.05	1.23	5.63	5.83	5.63	5.83	ns
LVC MOS15, QUIETIO, 4 mA	1.05	1.23	4.75	4.95	4.75	4.95	ns
LVC MOS15, QUIETIO, 6 mA	1.05	1.23	4.21	4.41	4.21	4.41	ns
LVC MOS15, QUIETIO, 8 mA	1.05	1.23	4.05	4.25	4.05	4.25	ns
LVC MOS15, QUIETIO, 12 mA	1.05	1.23	3.74	3.94	3.74	3.94	ns
LVC MOS15, QUIETIO, 16 mA	1.05	1.23	3.52	3.72	3.52	3.72	ns
LVC MOS15, Slow, 2 mA	1.05	1.23	4.32	4.52	4.32	4.52	ns
LVC MOS15, Slow, 4 mA	1.05	1.23	3.58	3.78	3.58	3.78	ns
LVC MOS15, Slow, 6 mA	1.05	1.23	2.45	2.65	2.45	2.65	ns
LVC MOS15, Slow, 8 mA	1.05	1.23	2.46	2.66	2.46	2.66	ns
LVC MOS15, Slow, 12 mA	1.05	1.23	2.17	2.37	2.17	2.37	ns
LVC MOS15, Slow, 16 mA	1.05	1.23	2.15	2.35	2.15	2.35	ns
LVC MOS15, Fast, 2 mA	1.05	1.23	3.43	3.63	3.43	3.63	ns
LVC MOS15, Fast, 4 mA	1.05	1.23	2.42	2.62	2.42	2.62	ns
LVC MOS15, Fast, 6 mA	1.05	1.23	1.92	2.12	1.92	2.12	ns
LVC MOS15, Fast, 8 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns
LVC MOS15, Fast, 12 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns
LVC MOS15, Fast, 16 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns
LVC MOS15_JEDEC, QUIETIO, 2 mA	1.10	1.28	5.64	5.84	5.64	5.84	ns
LVC MOS15_JEDEC, QUIETIO, 4 mA	1.10	1.28	4.75	4.95	4.75	4.95	ns
LVC MOS15_JEDEC, QUIETIO, 6 mA	1.10	1.28	4.21	4.41	4.21	4.41	ns
LVC MOS15_JEDEC, QUIETIO, 8 mA	1.10	1.28	4.06	4.26	4.06	4.26	ns
LVC MOS15_JEDEC, QUIETIO, 12 mA	1.10	1.28	3.75	3.95	3.75	3.95	ns
LVC MOS15_JEDEC, QUIETIO, 16 mA	1.10	1.28	3.53	3.73	3.53	3.73	ns
LVC MOS15_JEDEC, Slow, 2 mA	1.10	1.28	4.32	4.52	4.32	4.52	ns
LVC MOS15_JEDEC, Slow, 4 mA	1.10	1.28	3.56	3.76	3.56	3.76	ns
LVC MOS15_JEDEC, Slow, 6 mA	1.10	1.28	2.44	2.64	2.44	2.64	ns
LVC MOS15_JEDEC, Slow, 8 mA	1.10	1.28	2.47	2.67	2.47	2.67	ns
LVC MOS15_JEDEC, Slow, 12 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns
LVC MOS15_JEDEC, Slow, 16 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns
LVC MOS15_JEDEC, Fast, 2 mA	1.10	1.28	3.43	3.63	3.43	3.63	ns
LVC MOS15_JEDEC, Fast, 4 mA	1.10	1.28	2.42	2.62	2.42	2.62	ns
LVC MOS15_JEDEC, Fast, 6 mA	1.10	1.28	1.92	2.12	1.92	2.12	ns
LVC MOS15_JEDEC, Fast, 8 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns
LVC MOS15_JEDEC, Fast, 12 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns
LVC MOS15_JEDEC, Fast, 16 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns
LVC MOS12, QUIETIO, 2 mA	0.98	1.16	6.54	6.74	6.54	6.74	ns
LVC MOS12, QUIETIO, 4 mA	0.98	1.16	5.12	5.32	5.12	5.32	ns

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

I/O Standard	T _{IOPI}		T _{IOOP}		T _{IOTP}		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
LVC MOS12, QUIETIO, 6 mA	0.98	1.16	4.79	4.99	4.79	4.99	ns
LVC MOS12, QUIETIO, 8 mA	0.98	1.16	4.43	4.63	4.43	4.63	ns
LVC MOS12, QUIETIO, 12 mA	0.98	1.16	4.18	4.38	4.18	4.38	ns
LVC MOS12, Slow, 2 mA	0.98	1.16	5.12	5.32	5.12	5.32	ns
LVC MOS12, Slow, 4 mA	0.98	1.16	3.00	3.20	3.00	3.20	ns
LVC MOS12, Slow, 6 mA	0.98	1.16	2.91	3.11	2.91	3.11	ns
LVC MOS12, Slow, 8 mA	0.98	1.16	2.51	2.71	2.51	2.71	ns
LVC MOS12, Slow, 12 mA	0.98	1.16	2.25	2.45	2.25	2.45	ns
LVC MOS12, Fast, 2 mA	0.98	1.16	3.60	3.80	3.60	3.80	ns
LVC MOS12, Fast, 4 mA	0.98	1.16	2.49	2.69	2.49	2.69	ns
LVC MOS12, Fast, 6 mA	0.98	1.16	1.94	2.14	1.94	2.14	ns
LVC MOS12, Fast, 8 mA	0.98	1.16	1.82	2.02	1.82	2.02	ns
LVC MOS12, Fast, 12 mA	0.98	1.16	1.80	2.00	1.80	2.00	ns
LVC MOS12_JEDEC, QUIETIO, 2 mA	1.57	1.75	6.53	6.73	6.53	6.73	ns
LVC MOS12_JEDEC, QUIETIO, 4 mA	1.57	1.75	5.12	5.32	5.12	5.32	ns
LVC MOS12_JEDEC, QUIETIO, 6 mA	1.57	1.75	4.81	5.01	4.81	5.01	ns
LVC MOS12_JEDEC, QUIETIO, 8 mA	1.57	1.75	4.44	4.64	4.44	4.64	ns
LVC MOS12_JEDEC, QUIETIO, 12 mA	1.57	1.75	4.20	4.40	4.20	4.40	ns
LVC MOS12_JEDEC, Slow, 2 mA	1.57	1.75	5.14	5.34	5.14	5.34	ns
LVC MOS12_JEDEC, Slow, 4 mA	1.57	1.75	2.99	3.19	2.99	3.19	ns
LVC MOS12_JEDEC, Slow, 6 mA	1.57	1.75	2.90	3.10	2.90	3.10	ns
LVC MOS12_JEDEC, Slow, 8 mA	1.57	1.75	2.50	2.70	2.50	2.70	ns
LVC MOS12_JEDEC, Slow, 12 mA	1.57	1.75	2.26	2.46	2.26	2.46	ns
LVC MOS12_JEDEC, Fast, 2 mA	1.57	1.75	3.60	3.80	3.60	3.80	ns
LVC MOS12_JEDEC, Fast, 4 mA	1.57	1.75	2.49	2.69	2.49	2.69	ns
LVC MOS12_JEDEC, Fast, 6 mA	1.57	1.75	1.94	2.14	1.94	2.14	ns
LVC MOS12_JEDEC, Fast, 8 mA	1.57	1.75	1.83	2.03	1.83	2.03	ns
LVC MOS12_JEDEC, Fast, 12 mA	1.57	1.75	1.80	2.00	1.80	2.00	ns

Notes:

1. The Spartan-6Q FPGA -1L values are listed in Table 28.

Table 30 summarizes the value of T_{IOTPHZ}. T_{IOTPHZ} is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is enabled (i.e., a high impedance state). These delays are measured using LVC MOS25, Fast, 12 mA.

Table 30: IOB 3-state ON Output Switching Characteristics (T_{IOTPHZ})

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
T _{IOTPHZ}	T input to Pad high-impedance	1.39	1.59	1.59	1.91	ns

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair				
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324		
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5	
1.8V	LVCMOS18, LVCMOS18_JEDEC	2	Fast	39	46	39	47	
			Slow	65	75	65	74	
			QuietIO	80	80	80	85	
		4	Fast	22	25	22	25	
			Slow	38	36	38	29	
			QuietIO	45	40	45	35	
		6	Fast	16	18	16	17	
			Slow	27	25	27	19	
			QuietIO	30	28	30	23	
		8	Fast	13	15	13	14	
			Slow	16	18	16	16	
			QuietIO	25	22	25	18	
		12	Fast	5	7	5	5	
			Slow	7	8	7	6	
			QuietIO	11	10	11	8	
		16	Fast	4	5	4	4	
			Slow	7	8	7	5	
			QuietIO	11	10	11	8	
		24	Fast	N/A	5	N/A	3	
			Slow	N/A	8	N/A	8	
			QuietIO	N/A	10	N/A	8	
	HSTL_I_18				9	10	9	9
	HSTL_II_18				N/A	5	N/A	6
	HSTL_III_18				9	10	9	11
	DIFF_HSTL_I_18				27	30	27	27
	DIFF_HSTL_II_18				N/A	15	N/A	18
	DIFF_HSTL_III_18				27	30	27	33
MOBILE_DDR ⁽³⁾				12	14	12	14	
DIFF_MOBILE_DDR ⁽³⁾				36	42	36	42	
SSTL_18_I ⁽³⁾				9	10	9	10	
SSTL_18_II ⁽³⁾				N/A	5	N/A	4	
DIFF_SSTL_18_I ⁽³⁾				27	30	27	30	
DIFF_SSTL_18_II ⁽³⁾				N/A	15	N/A	12	

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

V _{CCO}	I/O Standard	Drive	Slew	SSO Limit per V _{CCO} /GND Pair				
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324		
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5	
3.3V	LVTTTL	2	Fast	53	65	53	62	
			Slow	70	80	70	73	
			QuietIO	79	89	79	91	
		4	Fast	23	30	23	27	
			Slow	34	41	34	37	
			QuietIO	44	49	44	46	
		6	Fast	16	21	16	20	
			Slow	21	28	21	25	
			QuietIO	34	39	34	34	
		8	Fast	12	16	12	15	
			Slow	16	22	16	19	
			QuietIO	27	28	27	24	
		12	Fast	1	3	1	1	
			Slow	2	5	2	4	
			QuietIO	2	10	2	8	
		16	Fast	1	3	1	1	
			Slow	1	7	1	2	
			QuietIO	3	11	3	8	
		24	Fast	1	2	1	1	
			Slow	2	5	2	2	
			QuietIO	8	9	8	8	
	PCI33_3				18	19	18	19
	PCI66_3				18	19	18	19
	SSTL_3_I				5	8	5	8
	SSTL_3_II				3	5	3	3
	DIFF_SSTL_3_I				15	24	15	24
	DIFF_SSTL_3_II				9	15	9	9
	SDIO				17	18	17	15

Input/Output Logic Switching Characteristics

Table 35: ILOGIC2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
Setup/Hold						
T _{ICE0CK} /T _{ICKCE0}	CE0 pin Setup/Hold with respect to CLK	0.56/ −0.30	0.56/ −0.25	0.79/ −0.22	1.21/ −0.52	ns
T _{ISRCK} /T _{ICKSR}	SR pin Setup/Hold with respect to CLK	0.74/ −0.23	0.74/ −0.22	0.98/ −0.20	1.31/ −0.45	ns
T _{IDOCK} /T _{IOCKD}	D pin Setup/Hold with respect to CLK without Delay	1.19/ −0.83	1.36/ −0.83	1.73/ −0.83	2.18/ −1.77	ns
T _{IDOCKD} /T _{IOCKDD}	DDLY pin Setup/Hold with respect to CLK (using IODELAY2)	0.31/ 0.00	0.47/ 0.00	0.54/ 0.00	0.63/ −0.39	ns
Combinatorial						
T _{IDI}	D pin to O pin propagation delay, no Delay	0.95	1.28	1.53	2.25	ns
T _{IDID}	DDLY pin to O pin propagation delay (using IODELAY2)	0.23	0.39	0.44	0.74	ns
Sequential Delays						
T _{IDLO}	D pin to Q pin using flip-flop as a latch without Delay	1.56	1.86	2.39	3.49	ns
T _{IDLOD}	DDLY pin to Q1 pin using flip-flop as a latch (using IODELAY2)	0.68	0.97	1.20	1.94	ns
T _{ICKQ}	CLK to Q outputs for XC devices	1.03	1.24	1.43	2.11	ns
	CLK to Q outputs for XA and XQ devices	1.38	N/A	1.78	2.11	ns
T _{RQ_ILOGIC2}	SR pin to Q outputs	1.81	1.81	2.50	3.05	ns

Table 36: OLOGIC2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
Setup/Hold						
T _{ODCK} /T _{OOCKD}	D1/D2 pins Setup/Hold with respect to CLK	0.81/ −0.05	0.86/ −0.05	1.18/ 0.00	1.73/ −0.27	ns
T _{OOCECK} /T _{OCKOCE}	OCE pin Setup/Hold with respect to CLK	0.75/ −0.10	0.75/ −0.10	1.01/ −0.05	1.66/ −0.23	ns
T _{OSRCK} /T _{OCKSR}	SR pin Setup/Hold with respect to CLK	0.70/ −0.28	0.79/ −0.28	1.03/ −0.23	1.39/ −0.47	ns
T _{OTCK} /T _{OCKT}	T1/T2 pins Setup/Hold with respect to CLK	0.24/ −0.08	0.56/ −0.06	0.83/ −0.01	0.99/ −0.19	ns
T _{OTCECK} /T _{OCKTCE}	TCE pin Setup/Hold with respect to CLK	0.58/ −0.06	0.72/ −0.06	1.18/ −0.01	1.51/ −0.13	ns
Sequential Delays						
T _{OOCKQ}	CLK to OQ/TQ out for XC devices	0.48	0.51	0.74	0.74	ns
	CLK to OQ/TQ out for XA and XQ devices	0.85	N/A	1.16	0.74	ns
T _{RQ_OLOGIC2}	SR pin to OQ/TQ out	1.81	1.81	2.50	3.05	ns

Block RAM Switching Characteristics

Table 43: Block RAM Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
Block RAM Clock to Out Delays						
T _{RCKO_DO}	Clock CLK to DOUT output (without output register) ⁽¹⁾	1.85	2.10	2.10	3.50	ns, Max
T _{RCKO_DO_REG}	Clock CLK to DOUT output (with output register) ⁽²⁾	1.60	1.75	1.75	2.30	ns, Max
Setup and Hold Times Before/After Clock CLK						
T _{RCCK_ADDR} /T _{RCKC_ADDR}	ADDR inputs for XC devices ⁽³⁾	0.35/ 0.10	0.40/ 0.12	0.40/ 0.12	0.50/ 0.15	ns, Min
	ADDR inputs for XA and XQ devices ⁽³⁾	0.35/ 0.17	N/A	0.40/ 0.17	0.50/ 0.15	ns, Min
T _{RDCK_DI} /T _{RCKD_DI}	DIN inputs ⁽⁴⁾	0.30/ 0.10	0.30/ 0.10	0.30/ 0.10	0.40/ 0.15	ns, Min
T _{RCCK_EN} /T _{RCKC_EN}	Block RAM Enable (EN) input	0.22/ 0.05	0.25/ 0.06	0.25/ 0.06	0.44/ 0.10	ns, Min
T _{RCCK_REGCE} /T _{RCKC_REGCE}	CE input of output register	0.20/ 0.10	0.20/ 0.10	0.20/ 0.10	0.28/ 0.15	ns, Min
T _{RCCK_WE} /T _{RCKC_WE}	Write Enable (WE) input	0.25/ 0.10	0.33/ 0.10	0.33/ 0.10	0.28/ 0.15	ns, Min
Maximum Frequency						
F _{MAX}	Block RAM in all modes	320	280	280	150	MHz

Notes:

- T_{RCKO_DO} includes T_{RCKO_DOA} and T_{RCKO_DOPA} as well as the B port equivalent timing parameters.
- $T_{RCKO_DO_REG}$ includes $T_{RCKO_DOA_REG}$ and $T_{RCKO_DOPA_REG}$ as well as the B port equivalent timing parameters.
- The ADDR setup and hold must be met when EN is asserted (even when WE is deasserted). Otherwise, block RAM data corruption is possible.
- T_{RDCK_DI} includes both A and B inputs as well as the parity inputs of A and B.

Configuration Switching Characteristics

Table 47: Configuration Switching Characteristics⁽¹⁾

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
Power-up Timing Characteristics						
T _{PL} ⁽²⁾	PROGRAM_B Latency	4	4	4	5	ms, Max
T _{POR} ⁽²⁾	Power-on reset (50 ms ramp time) ⁽³⁾	5/30	5/34	5/40	5/40	ms, Min/Max
	Power-on reset (10 ms ramp time)	5/25	5/29	5/35	5/40	ms, Min/Max
T _{PROGRAM}	PROGRAM_B Pulse Width	500	500	500	500	ns, Min
Slave Serial Mode Programming Switching						
T _{DCCK} /T _{CCKD}	DIN Setup/Hold, slave mode	6.0/1.0	6.0/1.0	6.0/1.0	8.0/2.0	ns, Min
T _{CCO}	CCLK to DOUT	12	12	12	17	ns, Max
F _{SCCK}	Slave mode external CCLK	80	80	80	50	MHz, Max
Slave SelectMAP Mode Programming Switching						
T _{SMDCK} /T _{SMCCKD}	SelectMAP Data Setup/Hold	6.0/1.0	6.0/1.0	6.0/1.0	8.0/2.0	ns, Min
T _{SMCSCCK} /T _{SMCCKCS}	CSI_B Setup/Hold	7.0/0.0	7.0/0.0	7.0/0.0	9.0/2.0	ns, Min
T _{SMWCCK} /T _{SMCCKW}	RDWR_B Setup/Hold	17.0/1.0	17.0/1.0	17.0/1.0	27.0/2.0	ns, Min
T _{SMCKCSO}	CSO_B clock to out	16	16	16	26	ns, Max
T _{SMCO}	CCLK to DATA out in readback	13	13	13	25	ns, Max
T _{SMCKBY}	CCLK to BUSY out in readback	12	12	12	17	ns, Max
F _{SMCK}	Maximum CCLK frequency (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	50	50	50	25	MHz, Max
	Maximum CCLK frequency (LX100 and LX100T in x8 mode, LX150, and LX150T only)	40	40	40	20	MHz, Max
	Maximum CCLK frequency (LX100 and LX100T in x16 mode only)	35	35	35	20	MHz, Max
F _{RBCK}	Maximum Readback CCLK frequency, including block RAM (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	20	20	20	4	MHz, Max
	Maximum Readback CCLK frequency, ignoring block RAM (POST_CRC) (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	50	50	50	30	MHz, Max
	Maximum Readback CCLK frequency, including block RAM (LX100, LX100T, LX150, and LX150T only)	12	12	12	4	MHz, Max
	Maximum Readback CCLK frequency, ignoring block RAM (POST_CRC) (LX100, LX100T, LX150, and LX150T only)	35	35	35	20	MHz, Max
Boundary-Scan Port Timing Specifications						
T _{TAPTCK}	TMS and TDI Setup time before TCK	10	10	10	17	ns, Min
T _{TCKTAP}	TMS and TDI Hold time after TCK	5.5	5.5	5.5	5.5	ns, Min
T _{TCKTDO}	TCK falling edge to TDO output valid	6.5	6.5	6.5	8	ns, Max
T _{TCKH}	TCK clock minimum High time	12	12	12	21	ns, Min
T _{TCKL}	TCK clock minimum Low time	12	12	12	21	ns, Min
F _{TCK}	Maximum configuration TCK clock frequency	33	33	33	18	MHz, Max
F _{TCKB}	Maximum boundary-scan TCK clock frequency	33	33	33	18	MHz, Max
F _{TCKAES}	Maximum AES key TCK clock frequency	2	2	2	2	MHz, Max

Table 54: Switching Characteristics for the Delay-Locked Loop (DLL)⁽¹⁾

Symbol	Description	Speed Grade								Units
		-3		-3N		-2		-1L		
		Min	Max	Min	Max	Min	Max	Min	Max	
Output Frequency Ranges										
CLKOUT_FREQ_CLK0	Frequency for the CLK0 and CLK180 outputs.	5	280	5	280	5	250	5	175	MHz
CLKOUT_FREQ_CLK90	Frequency for the CLK90 and CLK270 outputs.	5	200	5	200	5	200	5	175	MHz
CLKOUT_FREQ_2X	Frequency for the CLK2X and CLK2X180 outputs.	10	375	10	375	10	334	10	250	MHz
CLKOUT_FREQ_DV	Frequency for the CLKDV output.	0.3125	186	0.3125	186	0.3125	166	0.3125	88.6	MHz
Output Clock Jitter ⁽²⁾⁽³⁾⁽⁴⁾										
CLKOUT_PER_JITT_0	Period jitter at the CLK0 output.	–	±100	–	±100	–	±100	–	±100	ps
CLKOUT_PER_JITT_90	Period jitter at the CLK90 output.	–	±150	–	±150	–	±150	–	±150	ps
CLKOUT_PER_JITT_180	Period jitter at the CLK180 output.	–	±150	–	±150	–	±150	–	±150	ps
CLKOUT_PER_JITT_270	Period jitter at the CLK270 output.	–	±150	–	±150	–	±150	–	±150	ps
CLKOUT_PER_JITT_2X	Period jitter at the CLK2X and CLK2X180 outputs.	Maximum = ±[0.5% of CLKIN period + 100]								ps
CLKOUT_PER_JITT_DV1	Period jitter at the CLKDV output when performing integer division.	–	±150	–	±150	–	±150	–	±150	ps
CLKOUT_PER_JITT_DV2	Period jitter at the CLKDV output when performing non-integer division.	Maximum = ±[0.5% of CLKIN period + 100]								ps
Duty Cycle ⁽⁴⁾										
CLKOUT_DUTY_CYCLE_DLL	Duty cycle variation for the CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV outputs, including the BUFGMUX and clock tree duty-cycle distortion.	Typical = ±[1% of CLKIN period + 350]								ps
Phase Alignment ⁽⁴⁾										
CLKIN_CLKFB_PHASE	Phase offset between the CLKIN and CLKFB inputs (CLK_FEEDBACK = 1X).	–	±150	–	±150	–	±150	–	±250	ps
	Phase offset between the CLKIN and CLKFB inputs (CLK_FEEDBACK = 2X). ⁽⁶⁾	–	±250	–	±250	–	±250	–	±350	
CLKOUT_PHASE_DLL	Phase offset between DLL outputs for CLK0 to CLK2X (not CLK2X180).	Maximum = ±[1% of CLKIN period + 100]								ps
	Phase offset between DLL outputs for all others.	Maximum = ±[1% of CLKIN period + 150]						Maximum = ±[1% of CLKIN period + 200]		ps

Table 65: Global Clock Input to Output Delay With DCM in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in Source-Synchronous Mode.							
T _{ICKOFDCM_0}	Global Clock and OUTFF <i>with</i> DCM	XC6SLX4	5.03	N/A	7.21	8.05	ns
		XC6SLX9	5.03	6.13	7.21	8.05	ns
		XC6SLX16	5.08	5.51	6.44	7.96	ns
		XC6SLX25	4.81	5.13	5.69	7.94	ns
		XC6SLX25T	4.81	5.13	5.69	N/A	ns
		XC6SLX45	5.26	5.69	6.63	7.92	ns
		XC6SLX45T	5.26	5.69	6.63	N/A	ns
		XC6SLX75	4.77	5.18	5.88	7.95	ns
		XC6SLX75T	4.77	5.18	5.88	N/A	ns
		XC6SLX100	4.72	5.11	5.76	8.59	ns
		XC6SLX100T	4.76	5.11	5.76	N/A	ns
		XC6SLX150	4.90	5.30	5.93	7.93	ns
		XC6SLX150T	4.90	5.30	5.93	N/A	ns
		XA6SLX4	5.35	N/A	7.21	N/A	ns
		XA6SLX9	5.35	N/A	7.21	N/A	ns
		XA6SLX16	5.42	N/A	6.44	N/A	ns
		XA6SLX25	5.13	N/A	5.69	N/A	ns
		XA6SLX25T	5.13	N/A	5.79	N/A	ns
		XA6SLX45	5.58	N/A	6.63	N/A	ns
		XA6SLX45T	5.58	N/A	6.63	N/A	ns
		XA6SLX75	5.09	N/A	5.87	N/A	ns
		XA6SLX75T	5.09	N/A	5.87	N/A	ns
		XA6SLX100	N/A	N/A	6.44	N/A	ns
		XQ6SLX75	N/A	N/A	5.87	7.95	ns
		XQ6SLX75T	5.09	N/A	5.87	N/A	ns
		XQ6SLX150	N/A	N/A	6.06	7.93	ns
		XQ6SLX150T	5.50	N/A	6.06	N/A	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

Table 68: Global Clock Input to Output Delay With DCM and PLL in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in System-Synchronous Mode and PLL in DCM2PLL Mode.							
T _{ICKOFDCM_PLL}	Global Clock and OUTFF with DCM and PLL	XC6SLX4	4.78	N/A	6.32	7.09	ns
		XC6SLX9	4.78	5.24	6.32	7.09	ns
		XC6SLX16	4.70	5.12	5.94	6.63	ns
		XC6SLX25	4.70	5.09	5.92	7.30	ns
		XC6SLX25T	4.70	5.09	5.92	N/A	ns
		XC6SLX45	4.63	4.98	5.83	7.26	ns
		XC6SLX45T	4.63	4.98	5.83	N/A	ns
		XC6SLX75	4.68	5.04	5.88	6.90	ns
		XC6SLX75T	4.68	5.04	5.88	N/A	ns
		XC6SLX100	4.72	5.07	5.92	7.77	ns
		XC6SLX100T	4.76	5.07	5.92	N/A	ns
		XC6SLX150	4.44	4.73	5.31	6.96	ns
		XC6SLX150T	4.44	4.73	5.31	N/A	ns
		XA6SLX4	5.07	N/A	6.18	N/A	ns
		XA6SLX9	5.07	N/A	6.18	N/A	ns
		XA6SLX16	5.22	N/A	5.77	N/A	ns
		XA6SLX25	5.01	N/A	5.80	N/A	ns
		XA6SLX25T	5.01	N/A	5.90	N/A	ns
		XA6SLX45	4.93	N/A	5.67	N/A	ns
		XA6SLX45T	4.93	N/A	5.67	N/A	ns
		XA6SLX75	4.94	N/A	5.70	N/A	ns
		XA6SLX75T	4.94	N/A	5.70	N/A	ns
		XA6SLX100	N/A	N/A	5.77	N/A	ns
		XQ6SLX75	N/A	N/A	5.70	6.90	ns
		XQ6SLX75T	4.94	N/A	5.70	N/A	ns
		XQ6SLX150	N/A	N/A	5.31	6.96	ns
		XQ6SLX150T	5.02	N/A	5.31	N/A	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

Table 71: Global Clock Setup and Hold Without DCM or PLL (Default Delay)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard. ⁽¹⁾							
T _{PSFD} / T _{PHFD}	Default Delay ⁽²⁾ Global Clock and IFF ⁽³⁾ without DCM or PLL	XC6SLX4	0.66/1.17	N/A	1.05/0.79	2.09/1.05	ns
		XC6SLX9	0.66/1.17	0.75/1.17	1.05/1.17	2.09/1.05	ns
		XC6SLX16	0.87/1.16	0.93/1.16	0.96/1.16	1.86/1.06	ns
		XC6SLX25	0.68/0.77	0.81/0.81	0.87/0.82	2.21/1.33	ns
		XC6SLX25T	0.68/0.77	0.81/0.81	0.87/0.82	N/A	ns
		XC6SLX45	0.40/1.05	0.42/1.17	0.64/1.20	1.61/1.67	ns
		XC6SLX45T	0.40/1.05	0.42/1.17	0.64/1.20	N/A	ns
		XC6SLX75	0.41/1.11	0.41/1.13	0.80/1.14	1.23/1.82	ns
		XC6SLX75T	0.41/1.11	0.41/1.13	0.80/1.14	N/A	ns
		XC6SLX100	0.39/1.12	0.39/1.23	0.39/1.28	1.13/1.94	ns
		XC6SLX100T	0.39/1.12	0.39/1.23	0.39/1.28	N/A	ns
		XC6SLX150	0.23/1.54	0.23/1.62	0.23/1.62	1.14/2.05	ns
		XC6SLX150T	0.23/1.54	0.23/1.62	0.23/1.62	N/A	ns
		XA6SLX4	0.73/1.18	N/A	1.05/0.80	N/A	ns
		XA6SLX9	0.73/1.18	N/A	1.05/0.80	N/A	ns
		XA6SLX16	0.90/1.20	N/A	0.96/0.75	N/A	ns
		XA6SLX25	0.70/0.81	N/A	0.87/0.91	N/A	ns
		XA6SLX25T	0.76/0.81	N/A	1.03/0.91	N/A	ns
		XA6SLX45	0.40/1.06	N/A	0.64/1.20	N/A	ns
		XA6SLX45T	0.40/1.06	N/A	0.64/1.20	N/A	ns
		XA6SLX75	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XA6SLX75T	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XA6SLX100	N/A	N/A	0.86/1.55	N/A	ns
		XQ6SLX75	N/A	N/A	0.80/1.18	1.23/1.82	ns
		XQ6SLX75T	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XQ6SLX150	N/A	N/A	0.28/1.57	1.14/2.05	ns
		XQ6SLX150T	0.28/1.78	N/A	0.28/1.57	N/A	ns

Notes:

- Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
- Default delay uses IODELAY2 tap 0.
- IFF = Input Flip-Flop or Latch.

Table 72: Global Clock Setup and Hold With DCM in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVC MOS25 Standard. ⁽¹⁾							
T _{PSDCM} / T _{PHDCM}	No Delay Global Clock and IFF ⁽²⁾ with DCM in System-Synchronous Mode	XC6SLX4	1.54/0.06	N/A	1.75/0.12	2.84/0.27	ns
		XC6SLX9	1.54/0.06	1.63/0.12	1.75/0.12	2.84/0.27	ns
		XC6SLX16	1.72/−0.18	1.87/−0.17	2.13/−0.17	2.31/0.26	ns
		XC6SLX25	1.70/−0.03	1.78/−0.02	2.00/−0.02	2.88/0.20	ns
		XC6SLX25T	1.70/0.07	1.78/0.08	2.00/0.08	N/A	ns
		XC6SLX45	1.74/−0.03	1.84/−0.02	2.02/−0.02	2.64/0.52	ns
		XC6SLX45T	1.74/−0.01	1.84/0.00	2.02/0.00	N/A	ns
		XC6SLX75	1.86/0.11	1.98/0.12	2.20/0.12	2.96/0.58	ns
		XC6SLX75T	1.86/0.11	1.98/0.12	2.20/0.12	N/A	ns
		XC6SLX100	1.64/0.07	1.72/0.08	1.97/0.08	2.70/0.99	ns
		XC6SLX100T	1.64/0.09	1.72/0.10	1.97/0.10	N/A	ns
		XC6SLX150	1.53/0.39	1.62/0.40	1.82/0.40	2.75/1.00	ns
		XC6SLX150T	1.53/0.39	1.62/0.40	1.82/0.40	N/A	ns
		XA6SLX4	1.65/0.16	N/A	1.75/0.26	N/A	ns
		XA6SLX9	1.65/0.16	N/A	1.75/0.26	N/A	ns
		XA6SLX16	1.88/0.02	N/A	2.13/0.03	N/A	ns
		XA6SLX25	1.80/0.16	N/A	2.05/0.17	N/A	ns
		XA6SLX25T	1.80/0.16	N/A	2.13/0.17	N/A	ns
		XA6SLX45	1.75/0.12	N/A	2.02/0.13	N/A	ns
		XA6SLX45T	1.75/0.12	N/A	2.02/0.13	N/A	ns
		XA6SLX75	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XA6SLX75T	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XA6SLX100	N/A	N/A	2.46/0.24	N/A	ns
		XQ6SLX75	N/A	N/A	2.20/0.12	2.96/0.58	ns
		XQ6SLX75T	1.87/0.11	N/A	2.20/0.12	N/A	ns
		XQ6SLX150	N/A	N/A	1.82/0.56	2.75/1.00	ns
		XQ6SLX150T	1.65/0.55	N/A	1.82/0.56	N/A	ns

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include DCM CLK0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 77: Global Clock Setup and Hold With DCM and PLL in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Example Data Input Set-Up and Hold Times Relative to a Forwarded Clock Input Pin, ⁽¹⁾ Using DCM, PLL, and Global Clock Buffer for the LVCMOS25 standard.							
T _{PSDCMPLL_0} / T _{PHDCMPLL_0}	No Delay Global Clock and IFF ⁽²⁾ with DCM in Source-Synchronous Mode and PLL in DCM2PLL Mode.	XC6SLX4	0.43/1.07	N/A	0.43/1.43	1.10/1.67	ns
		XC6SLX9	0.43/1.03	0.45/1.14	0.45/1.43	1.10/1.67	ns
		XC6SLX16	0.74/0.93	0.74/1.12	0.74/1.21	0.77/1.35	ns
		XC6SLX25	0.67/1.02	0.76/1.11	0.84/1.18	1.23/1.46	ns
		XC6SLX25T	0.67/1.02	0.76/1.11	0.84/1.18	N/A	ns
		XC6SLX45	0.65/0.99	0.65/1.04	0.71/1.12	1.18/1.58	ns
		XC6SLX45T	0.65/1.00	0.65/1.04	0.71/1.12	N/A	ns
		XC6SLX75	0.86/1.01	0.88/1.06	0.94/1.14	1.29/1.67	ns
		XC6SLX75T	0.86/1.01	0.88/1.06	0.94/1.14	N/A	ns
		XC6SLX100	0.50/1.10	0.56/1.10	0.61/1.17	0.84/2.24	ns
		XC6SLX100T	0.50/1.10	0.56/1.10	0.61/1.17	N/A	ns
		XC6SLX150	0.45/1.28	0.47/1.28	0.52/1.28	1.27/1.56	ns
		XC6SLX150T	0.45/1.28	0.47/1.28	0.52/1.28	N/A	ns
		XA6SLX4	0.74/1.00	N/A	0.74/1.43	N/A	ns
		XA6SLX9	0.74/1.00	N/A	0.74/1.43	N/A	ns
		XA6SLX16	1.81/1.15	N/A	1.81/1.03	N/A	ns
		XA6SLX25	0.89/1.01	N/A	0.96/1.05	N/A	ns
		XA6SLX25T	0.89/1.01	N/A	1.04/1.15	N/A	ns
		XA6SLX45	0.69/0.95	N/A	0.83/0.96	N/A	ns
		XA6SLX45T	0.69/0.95	N/A	0.83/0.96	N/A	ns
		XA6SLX75	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XA6SLX75T	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XA6SLX100	N/A	N/A	1.55/1.33	N/A	ns
		XQ6SLX75	N/A	N/A	1.06/0.96	1.29/1.67	ns
		XQ6SLX75T	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XQ6SLX150	N/A	N/A	0.64/1.30	1.27/1.56	ns
		XQ6SLX150T	0.58/1.30	N/A	0.64/1.30	N/A	ns

Notes:

- Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. The timing values were measured using the fine-phase adjustment feature of the DCM. These measurements include CMT jitter; DCM CLK0 driving PLL, PLL CLKOUT0 driving BUFG. Package skew is not included in these measurements.
- IFF = Input Flip-Flop

Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Spartan-6 FPGA source-synchronous transmitter and receiver data-valid windows.

Table 78: Duty Cycle Distortion and Clock-Tree Skew

Symbol	Description	Device ⁽¹⁾	Speed Grade				Units
			-3	-3N	-2	-1L	
T _{DCD_CLK}	Global Clock Tree Duty Cycle Distortion ⁽²⁾	LX4	0.20	N/A	0.20	0.35	ns
		LX9	0.20	0.20	0.20	0.35	ns
		LX16	0.20	0.20	0.20	0.35	ns
		LX25	0.20	0.20	0.20	0.35	ns
		LX25T	0.20	0.20	0.20	N/A	ns
		LX45	0.20	0.20	0.20	0.35	ns
		LX45T	0.20	0.20	0.20	N/A	ns
		LX75	0.20	0.20	0.20	0.35	ns
		LX75T	0.20	0.20	0.20	N/A	ns
		LX100	0.20	0.20	0.20	0.35	ns
		LX100T	0.20	0.20	0.20	N/A	ns
		LX150	0.35	0.35	0.35	0.35	ns
		LX150T	0.35	0.35	0.35	N/A	ns
T _{CKSKEW}	Global Clock Tree Skew ⁽³⁾	LX4	0.25	N/A	0.25	0.29	ns
		LX9	0.25	0.25	0.25	0.29	ns
		LX16	0.15	0.15	0.15	0.22	ns
		LX25	0.26	0.26	0.26	0.41	ns
		LX25T	0.26	0.26	0.26	N/A	ns
		LX45	0.20	0.20	0.20	0.28	ns
		LX45T	0.20	0.20	0.20	N/A	ns
		LX75	0.56	0.56	0.56	0.50	ns
		LX75T	0.56	0.56	0.56	N/A	ns
		XC6SLX100 ⁽⁴⁾	0.22	0.22	0.22	0.21	ns
		XA6SLX100 ⁽⁴⁾	N/A	N/A	0.43	N/A	ns
		LX100T	0.22	0.22	0.22	N/A	ns
		LX150	0.48	0.48	0.48	0.35	ns
		LX150T	0.48	0.48	0.48	N/A	ns
T _{DCD_BUFIO2}	I/O clock tree duty cycle distortion	LX devices	0.25	0.25	0.25	0.50	ns
		LXT devices	0.25	0.25	0.25	N/A	ns

Date	Version	Description of Revisions
06/14/10	1.5	In Table 2, added note 5 and added temperature range to V_{FS} and R_{FUSE}. Removed speed grade delineation, revised I_{RPD} description, and updated note 2 in Table 4. Added note 2 to Table 7. Added $DIFF_MOBILE_DDR$ to Table 8 and Table 10. Added note 4 to Table 15. Changed minimum DV_{PPIN} in Table 16. Updated $F_{GTPDRCLK}$ in Table 19. Increased maximum T_{LLSKEW} in Table 22. Updated descriptions and added data to Table 23. Removed note 1 and added new data to the Networking Applications section in Table 25. Updated Table 26 and Table 27 to the data in ISE v12.1 software with speed specification v1.08. In Table 28, added $DIFF_MOBILE_DDR$ and updated -4 speed grade data. Updated the maximum I/O pairs per bank in Table 33. Updated note 2 on Table 39. Revised the F_{MAX} in Table 44. In Table 47, updated description for $T_{SMCKCSO}$, revised values for T_{POR} and added Min value, added $T_{BPIICCK}$ and $T_{SPIICCK}$. Also in Table 47, added device dependencies to F_{SMCKCK} and F_{RBCKCK}. Updated and added data to Table 63 through Table 78, and Table 81. In Table 79, added data on the XC6SLX45-FG(G)676 and revised the XC6SLX45T and XC6SLX150T values. The following changes to this specification are addressed in the product change notice XC6SLX45-FG(G)676, <i>MCB Performance and JTAG Revision Code for Spartan-6 LX16 and LX45 FPGAs</i>. In Table 2, revised the V_{CCINT} to add the memory controller block extended performance specifications. In Table 25, changed the standard specifications and added extended performance specifications for the memory controller block and note 2. Added note 4 and updated values in Table 34.
06/24/10	1.6	Production release of XC6SLX45T (-2 and -3 speed grades), XC6SLX16 and XC6SLX45 (-3 speed grade) devices which includes changes to Table 26 and Table 27 (ISE v12.1 software with speed specification v1.08). Added the -3N speed grade, which designates Spartan-6 devices that do not support MCB functionality. This includes changes to Table 2 (note 2), Table 25 (note 4), and Switching Characteristics (Table 26). Updated Simultaneously Switching Outputs discussion. Added -3 speed grade values for T_{TAP} and F_{MINCAL} values in Table 39. In Table 40, updated T_{RPW} (-2 and -3 speed grade) values and F_{TOG} (-3 speed grade) values. In Table 48, updated T_{GIO} (-2 and -3 speed grade) values. Updated -3 values in spread spectrum section of Table 57.
07/16/10	1.7	Production release of specific devices listed in Table 26 and Table 27 using ISE v12.2 software with speed specification v1.11. Added note 4 advising designers of the patch which contains v1.11. Also updated the -1L speed specification to v1.04. Updated numerous -4 and -1L values. Added -4 T_{TAP} values and F_{MINCAL} to Table 39. Revised T_{CINCK}/T_{CKCIN} in Table 40. In Table 41, revised T_{SHCKO}. In Table 42, revised T_{REQ}. Added new -1L values to Table 47. Added and updated values in Table 79.
07/26/10	1.8	Production release of XC6SLX25, XC6SLX25T, XC6SLX100 and XC6SLX100T in the specific speed grades listed in Table 26 and Table 27 using ISE v12.2 software with speed specification v1.11. Added note 7 to Table 2 and moved V_{FS} and R_{FUSE} to a new Table 3. Added I_{HS} and note 4 to Table 4. Added note 1 to Table 28. Added and updated SSO limits per V_{CCO}/GND pairs in Table 34. Added note 3 to Table 47. In Table 54, removed -1L specifications for $CLKOUT_PER_JITT_DV1/2$ and revised $CLKIN_CLKFB_PHASE$ and $CLKOUT_PHASE_DLL$ values. Updated note 3 in both Table 56 and Table 57.
08/23/10	1.9	Updated values for $F_{GTPRANGE1}$, $F_{GTPRANGE2}$, and $F_{GPLLMIN}$ in Table 18. Revised -3 and -4 values in Table 21. Removed the -1L speed grade readback support restriction and note 3 in Table 47.
11/05/10	1.10	Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in Table 26 and Table 27 using ISE v12.3 software with speed specification v1.12 for the -2 speed grade available in the 12.3 <i>Speed Files Patch</i>. Added note 3 advising designers of the patch which contains v1.12. In Table 2, added note 4. In Table 4, added note 2. In Table 10, added notes 2 and 3. In Table 44, added note 2. In Table 47, updated symbol for $T_{SMWCKCK}/T_{SMCKCKW}$, changed -1L values for $T_{USERCCLKH}$ and $T_{USERCCLKL}$, and added and revised the modes for F_{MCKCK} and F_{SMCKCK}. In Table 53, redefined and expanded description for $CLKIN_FREQ_DLL$ and rewrote note 3. Updated title of Table 58. Also in Table 78, revised T_{DCD_CLK} for XC6SLX150 and XC6SLX150T. Changed description of T_{PSFD}/T_{PHFD} in Table 71. For the -1L speed grade, updated data sheet to ISE 12.3 software with speed specification v1.05 which revised the values in the following tables: Table 25, Table 28, Table 35, Table 36, Table 37, Table 40 through Table 43, Table 48 through Table 56, Table 62 through Table 78, Table 80, and Table 81. Updated Notice of Disclaimer.